

- Designed to be Used in Voltage-Limiting Applications
- 6.5-Ω On-State Connection Between Ports A and B
- Flow-Through Pinout for Ease of Printed Circuit Board Trace Routing
- Direct Interface With GTL+ Levels
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

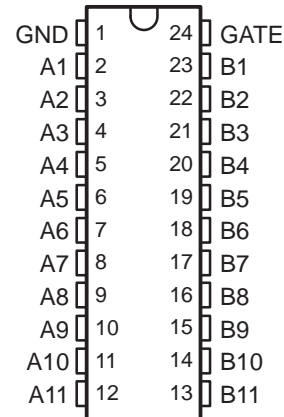
### description/ordering information

The SN74TVC3010 provides 11 parallel NMOS pass transistors with a common gate. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device can be used as a 10-bit switch with the gates cascaded together to a reference transistor. The low-voltage side of each pass transistor is limited to a voltage set by the reference transistor. This is done to protect components with inputs that are sensitive to high-state voltage-level overshoots. (See Application Information in this data sheet.)

All of the transistors in the TVC array have the same electrical characteristics; therefore, any one of them can be used as the reference transistor. Since, within the device, the characteristics from transistor to transistor are equal, the maximum output high-state voltage ( $V_{OH}$ ) is approximately the reference voltage ( $V_{REF}$ ), with minimal deviation from one output to another. This is a large benefit of the TVC solution over discrete devices. Because the fabrication of the transistors is symmetrical, either port connection of each bit can be used as the low-voltage side, and the I/O signals are bidirectional through each FET.

### DBQ, DGV, DW, OR PW PACKAGE (TOP VIEW)



### ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – DW	Tube	SN74TVC3010DW	TVC3010
		Tape and reel	SN74TVC3010DWR	
	SSOP (QSOP) – DBQ	Tape and reel	SN74TVC3010DBQR	TVC3010
	TSSOP – PW	Tape and reel	SN74TVC3010PWR	TT010
	TVSOP – DGV	Tape and reel	SN74TVC3010DGVR	TT010

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

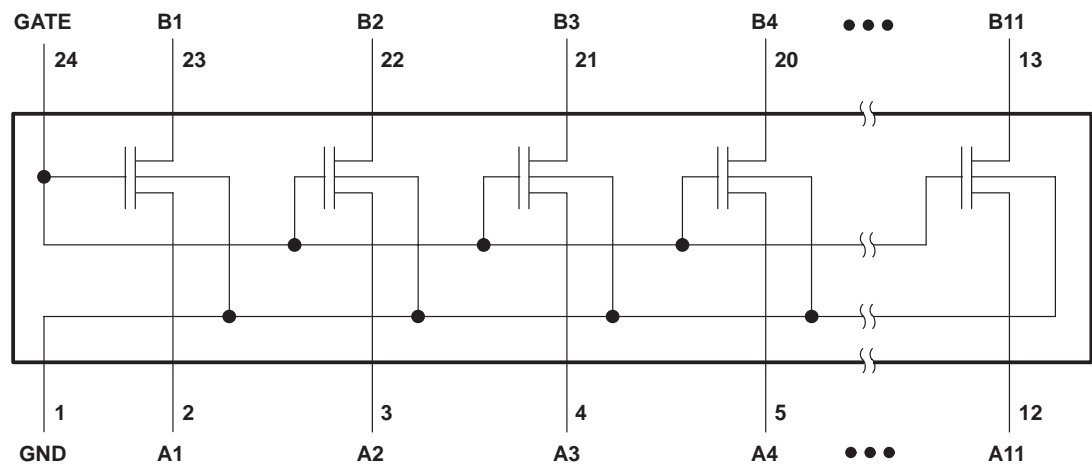
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated

SN74TVC3010  
10-BIT VOLTAGE CLAMP

SCDS088G – APRIL 1999 – REVISED AUGUST 2003

simplified schematic



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Input/output voltage range, $V_{I/O}$ (see Note 1)	–0.5 V to 7 V
Continuous channel current	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2):	
DBQ package	61°C/W
DGV package	86°C/W
DW package	46°C/W
PW package	88°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and input/output negative-voltage ratings may be exceeded if the input and input/output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	TYP	MAX	UNIT
$V_{I/O}$	Input/output voltage	0		5	V
$V_{GATE}$	GATE voltage	0		5	V
$I_{PASS}$	Pass-transistor current		20	64	mA
$T_A$	Operating free-air temperature	–40		85	°C

**application operating conditions (see Figure 3)**

		MIN	TYP	MAX	UNIT
V <sub>BIAS</sub>	BIAS voltage	V <sub>REF</sub> + 0.6	2.1	5	V
V <sub>GATE</sub>	GATE voltage	V <sub>REF</sub> + 0.6	2.1	5	V
V <sub>REF</sub>	Reference voltage	0	1.5	4.4	V
V <sub>DPU</sub>	Drain pullup voltage	2.36	2.5	2.64	V
I <sub>PASS</sub>	Pass-transistor current		14		mA
I <sub>REF</sub>	Reference-transistor current		5		μA
T <sub>A</sub>	Operating free-air temperature	–40		85	°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS			MIN	TYP†	MAX	UNIT
V <sub>IK</sub>	V <sub>BIAS</sub> = 0,	I <sub>I</sub> = –18 mA				–1.2	V
V <sub>OL</sub>	I <sub>REF</sub> = 5 μA, V <sub>DPU</sub> = 2.625 V,	V <sub>REF</sub> = 1.365 V, R <sub>DPU</sub> = 150 Ω	V <sub>S</sub> = 0.175 V, See Figure 1			350	mV
C <sub>i</sub> (GATE)	V <sub>I</sub> = 3 V or 0				24		pF
C <sub>io</sub> (off)	V <sub>O</sub> = 3 V or 0				4	12	pF
C <sub>io</sub> (on)	V <sub>O</sub> = 3 V or 0				12	30	pF
r <sub>on</sub> ‡	I <sub>REF</sub> = 5 μA, V <sub>DPU</sub> = 2.625 V,	V <sub>REF</sub> = 1.365 V, R <sub>DPU</sub> = 150 Ω	V <sub>S</sub> = 0.175 V, See Figure 1			12.5	Ω

† All typical values are at T<sub>A</sub> = 25°C.

‡ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

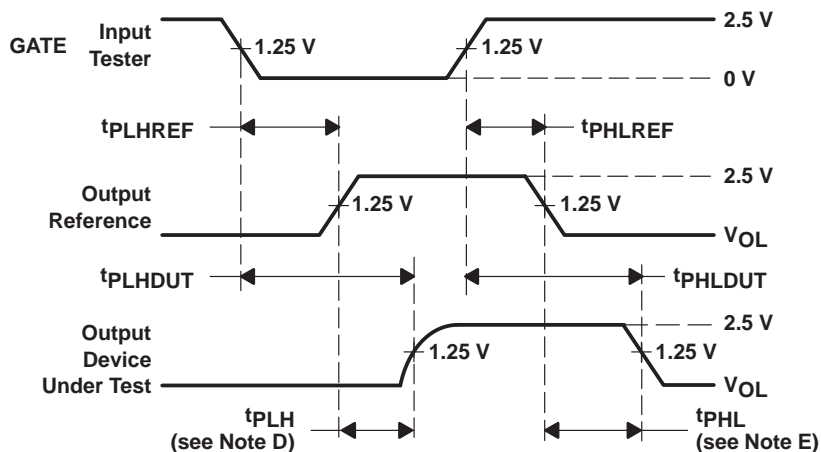
**switching characteristics over recommended operating free-air temperature range, V<sub>DPU</sub> = 2.36 V to 2.64 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
t <sub>PLH</sub>	A or B	B or A	0	4	ns
t <sub>PHL</sub>			0	4	

## SCDS088G – APRIL 1999 – REVISED AUGUST 2003

The schematic diagram illustrates the test setup for the TVC3010 device. It shows the connection of the TVC3010 to a Motherboard Interface and an Open-Drain Test Interface. The Motherboard Interface includes a 3.3V supply, a 200kΩ resistor, and a GATE pin (24). The Open-Drain Test Interface includes a VREF pin (A1), a VBIAS pin (B1), and a VDS pin (A11). The TVC3010 is connected to these pins and has its own internal resistors ( $R_{DPU} = 150\Omega$ ) and capacitors ( $C_{DPU} = 100pF$ ).

DEFINITION	SYMBOL
Output tested	†
Output reference	‡
Input tested	§



## VOLTAGE WAVEFORMS

### PROPAGATION DELAY TIMES

- ### Figure 1. Tester Calibration Setup and Voltage Waveforms

## APPLICATION INFORMATION

### TVC background information

In personal computer (PC) architecture, there are industry-accepted bus standards. These standards define, among other things, the I/O voltage levels at which the bus communicates. Examples include the GTL+ host bus, the AGP graphics port, and the PCI local bus. In new designs, the system components must communicate with existing bus infrastructure. Providing an evolutionary upgrade path is important in the design of PC architecture, but the existing bus standards must be preserved.

To achieve the ever-present need for smaller, faster, lighter devices that draw less power, yet have faster performance, most new high-performance digital integrated circuits are being designed and produced with advanced submicron semiconductor process technologies. These devices have thin gate-oxide or short channel lengths and very low absolute-maximum voltages that can be tolerated at the inputs/outputs (I/Os) without causing damage. In many cases, the I/Os of these devices are not tolerant of the high-state voltage levels on the preexisting buses with which they must communicate. Therefore, it became necessary to protect the I/Os of devices by limiting the I/O voltages.

The Texas Instruments (TI) translation voltage-clamp (TVC) family was designed specifically for protecting sensitive I/Os (see Figure 2). The information in this data sheet describes the I/O-protection application of the TVC family and should enable the design engineer to successfully implement an I/O-protection circuit utilizing the TI TVC solution.

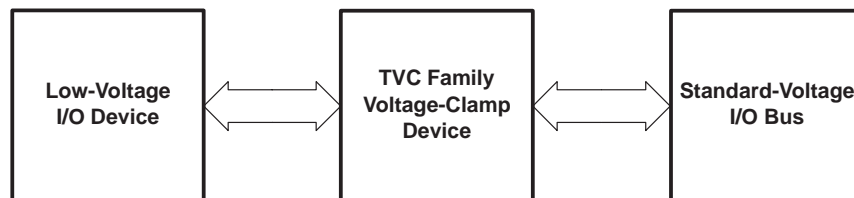
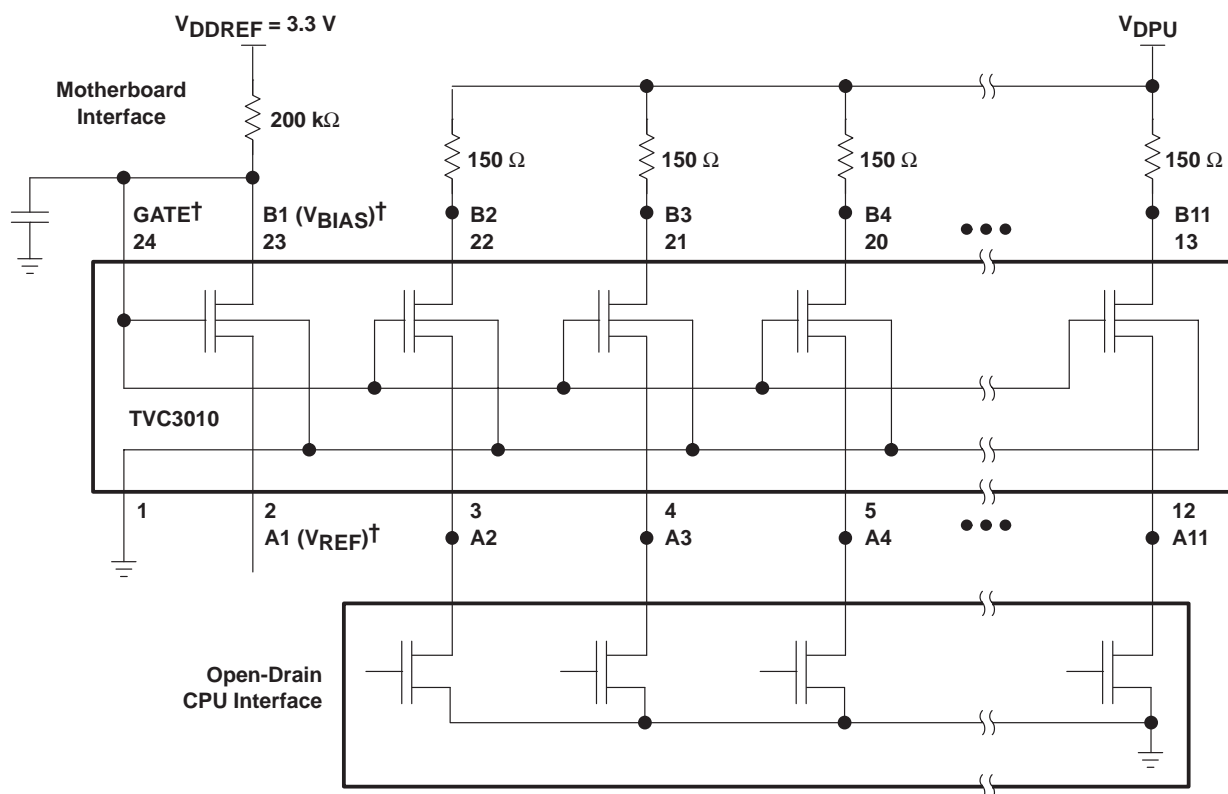


Figure 2. Thin Gate-Oxide Protection Application

### APPLICATION INFORMATION

#### TVC voltage-limiting application

For the voltage-limiting configuration, the common GATE input must be connected to one side (A or B) of any one of the transistors (see Figure 3). This connection determines the  $V_{BIAS}$  input of the reference transistor. The  $V_{BIAS}$  input is connected through a pullup resistor (typically, 200 k $\Omega$ ) to the  $V_{DD}$  supply. A filter capacitor on  $V_{BIAS}$  is recommended. The opposite side of the reference transistor is used as the reference voltage ( $V_{REF}$ ) connection. The  $V_{REF}$  input must be less than  $V_{DDREF} - 1$  V to bias the reference transistor into conduction. The reference transistor regulates the gate voltage ( $V_{GATE}$ ) of all the pass transistors.  $V_{GATE}$  is determined by the characteristic gate-to-source voltage difference ( $V_{GS}$ ) because  $V_{GATE} = V_{REF} + V_{GS}$ . The low-voltage side of the pass transistors has a high-level voltage limited to a maximum of  $V_{GATE} - V_{GS}$ , or  $V_{REF}$ .



†  $V_{REF}$  and  $V_{BIAS}$  can be applied to any one of the pass transistors. GATE must be connected externally to  $V_{BIAS}$ .

Figure 3. Typical Application Circuit

## APPLICATION INFORMATION

### electrical characteristics

The electrical characteristics of the NMOS transistors used in the TVC devices are illustrated by TI SPICE simulations. Figure 4 shows the test configuration for the TI SPICE simulations. The results, shown in Figures 5 and 6, show the current through a pass transistor versus the voltage at the source for different reference voltages. The plots of the dc characteristics clearly reveal that the device clamps at the desired reference voltage for the varying device environments.

Figure 5 shows the V-I characteristics, with low reference voltages and a reference-transistor drain-supply voltage of 3.3 V. To further investigate the spread of the V-I characteristic curves,  $V_{REF}$  was held at 2.5 V and  $I_{REF}$  was increased by raising  $V_{DDREF}$  (see Figure 6). The result was a tighter grouping of the V-I curves.

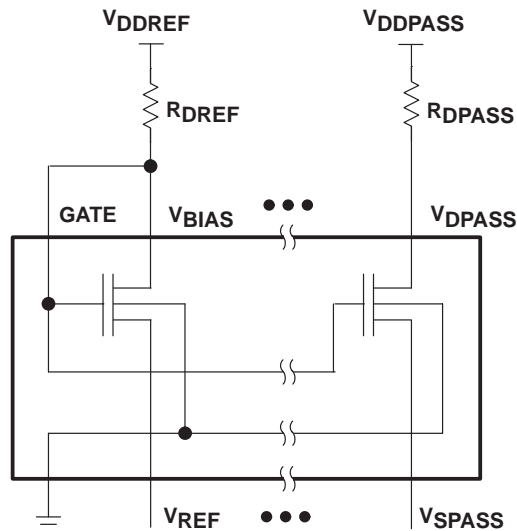


Figure 4. TI SPICE Simulation Schematic and Voltage-Node Names

## APPLICATION INFORMATION

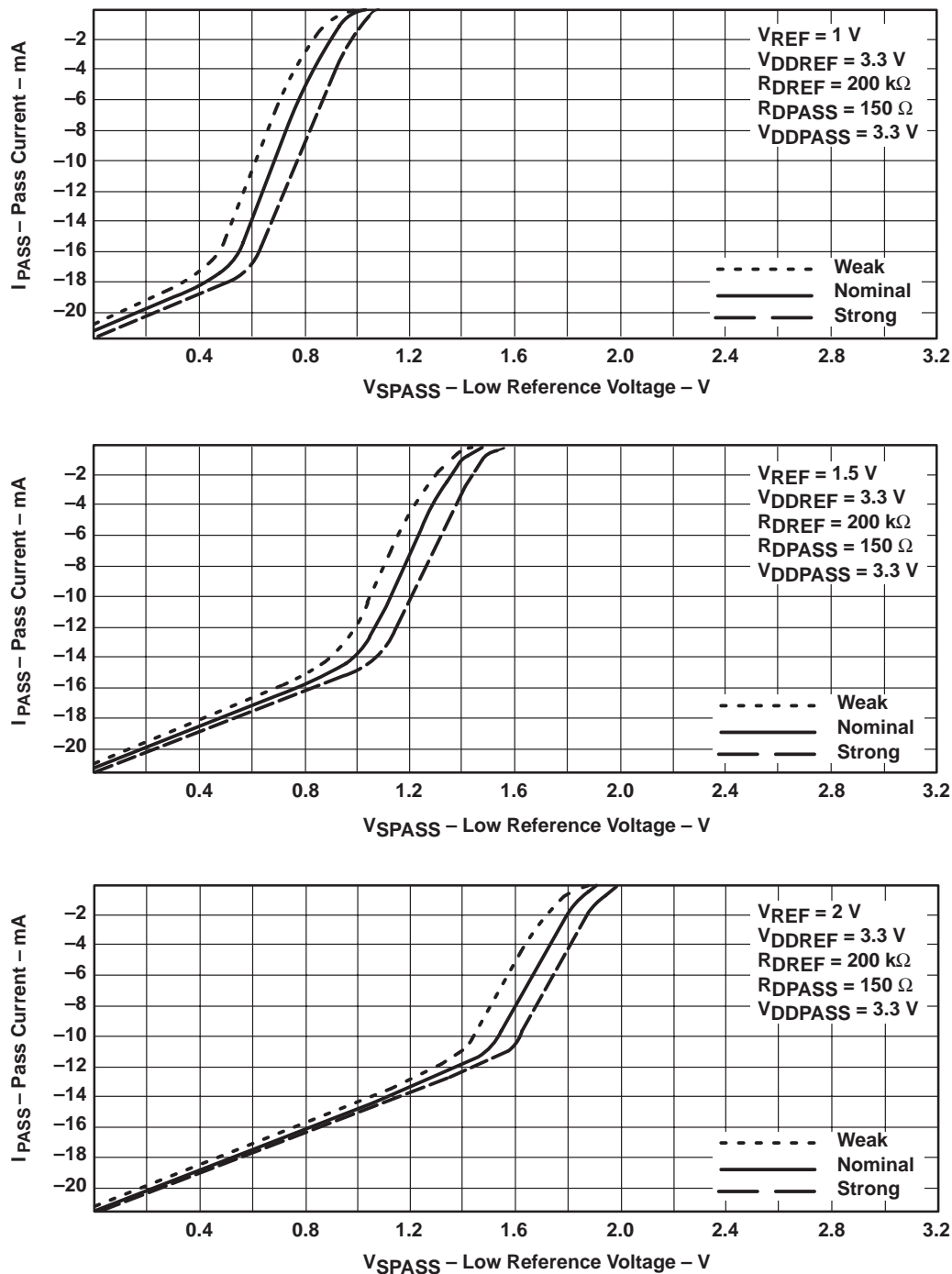


Figure 5. Electrical Characteristics at Low  $V_{REF}$  Voltages



## APPLICATION INFORMATION

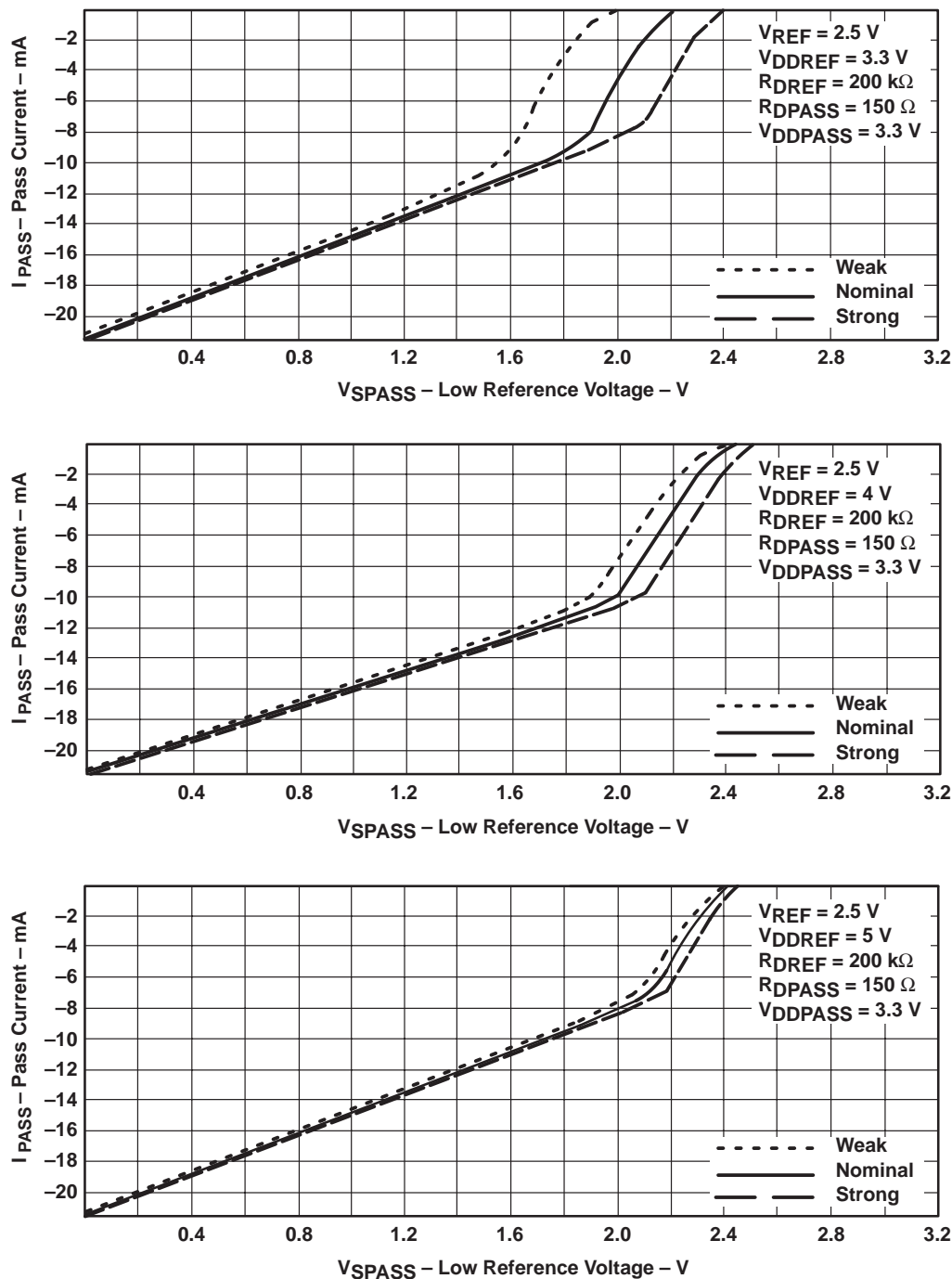


Figure 6. Electrical Characteristics at  $V_{REF} = 2.5\text{ V}$

### APPLICATION INFORMATION

#### features and benefits

The TVC family has several features that benefit a system designer when implementing a sensitive-I/O-protection solution. Table 1 lists these features and their associated benefits.

**Table 1. Features and Benefits**

FEATURES	BENEFITS
Any FET can be used as the reference transistor.	Ease of layout
All FETs on one die, tight process control	Very low spread of $V_O$ relative to $V_{REF}$
No active control logic (passive device)	No logic power supply ( $V_{CC}$ ) required
Flow-through pinout	Ease of trace routing
Devices offered in different bit-widths and packages	Optimizes design and cost effectiveness
Designer flexibility with $V_{REF}$ input	Allows migration to lower-voltage I/Os without board redesign

#### conclusion

The TI TVC family provides the designer with a solution for protection of circuits with I/Os that are sensitive to high-state voltage-level overshoots. The flexibility of TVC enables a low-voltage migration path for advanced designs to align with industry standards.

#### frequently asked questions (FAQ)

- Q: Can any of the transistors in the array be used as the reference transistor?  
A: Yes, any transistor can be used as long as its  $V_{BIAS}$  pin is connected to the GATE pin.
- Q: In the recommended operating conditions table of the data sheet, the typical  $V_{BIAS}$  is 3.3 V. Should  $V_{BIAS}$  be equal to or greater than  $V_{REF}$  on the reference transistor?  
A:  $V_{BIAS}$  is a variable that is determined by  $V_{REF}$ .  $V_{BIAS}$  is connected to  $V_{DD}$  through a resistor to allow the bias voltage to be controlled by  $V_{REF}$ .  $V_{DD}$  can be as high as 5.5 V.  $V_{REF}$  needs to be at least 1 V less than  $V_{DDREF}$  on the reference transistor.
- Q: Do both A and B ports have 5-V I/O tolerance or is 5-V I/O tolerance provided only on the low-voltage side?  
A: Both ports are 5-V tolerant.

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN

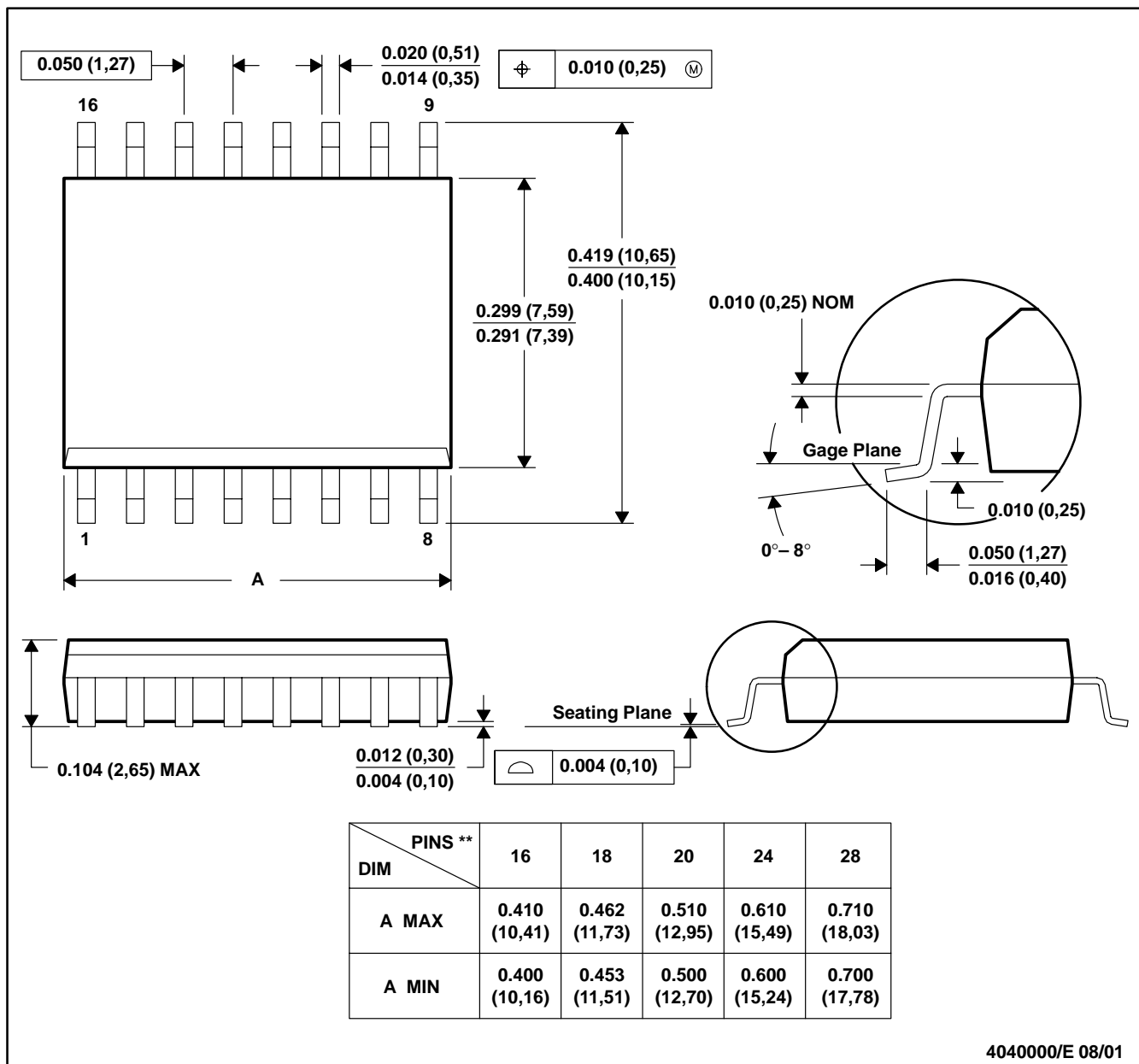


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

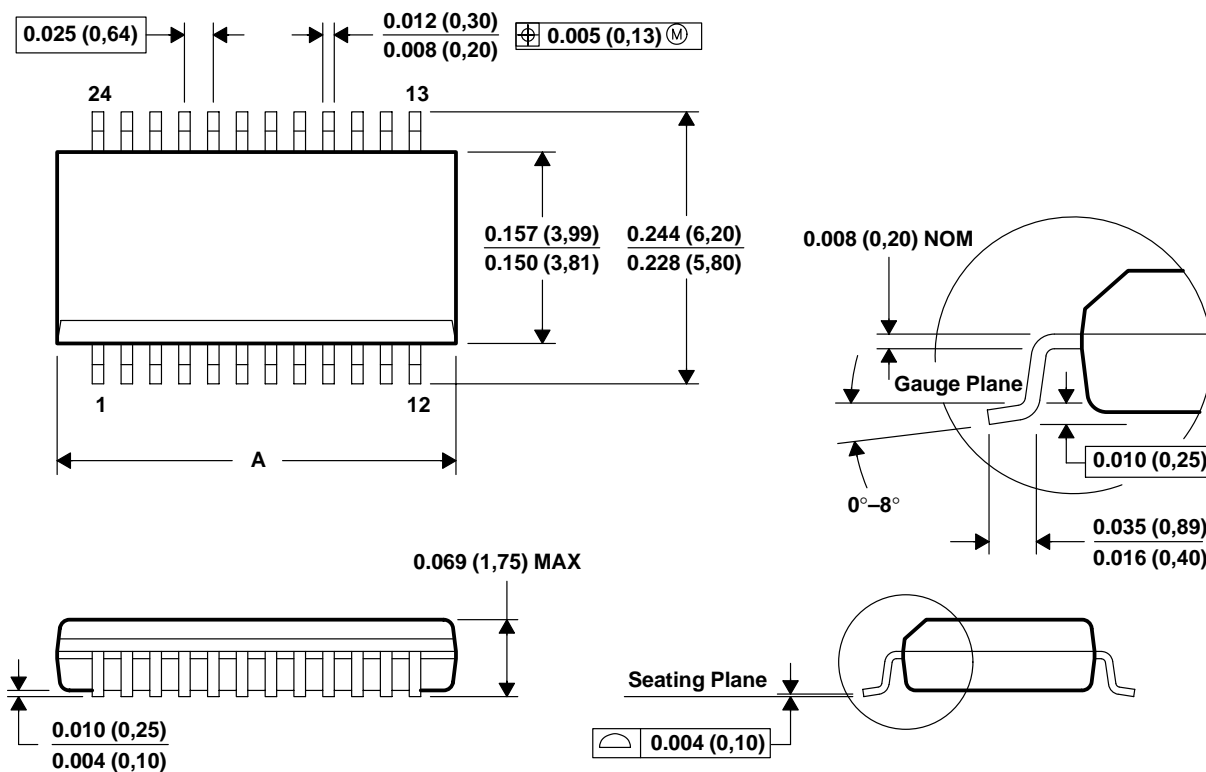
16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-013

## DBQ (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE



PINS **	16	20	24	28
DIM				
A MAX	0.197 (5,00)	0.344 (8,74)	0.344 (8,74)	0.394 (10,01)
A MIN	0.189 (4,80)	0.337 (8,56)	0.337 (8,56)	0.386 (9,80)
MO-137 VARIATION	AB	AD	AE	AF

4073301/F 02/02

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-137.

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

<b>Products</b>		<b>Applications</b>	
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2003, Texas Instruments Incorporated